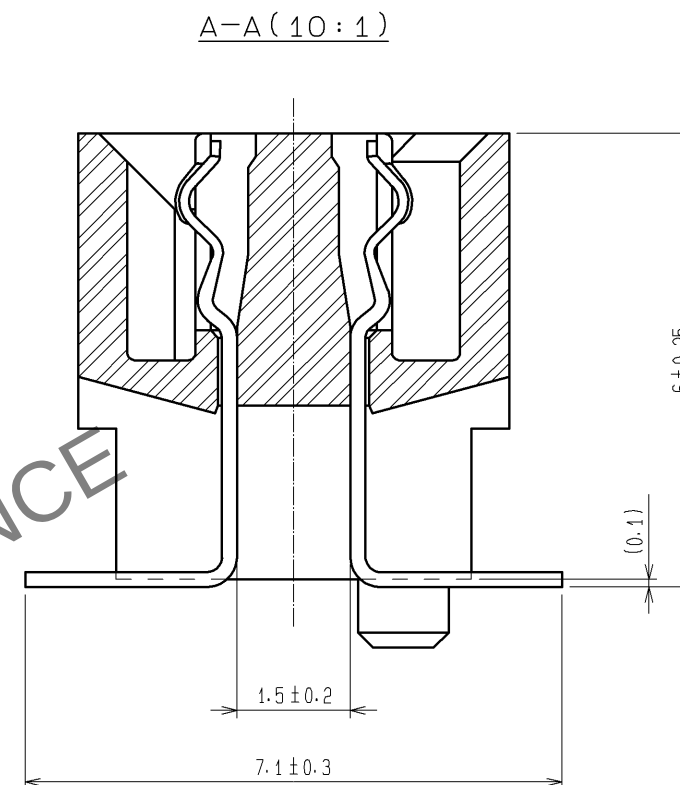
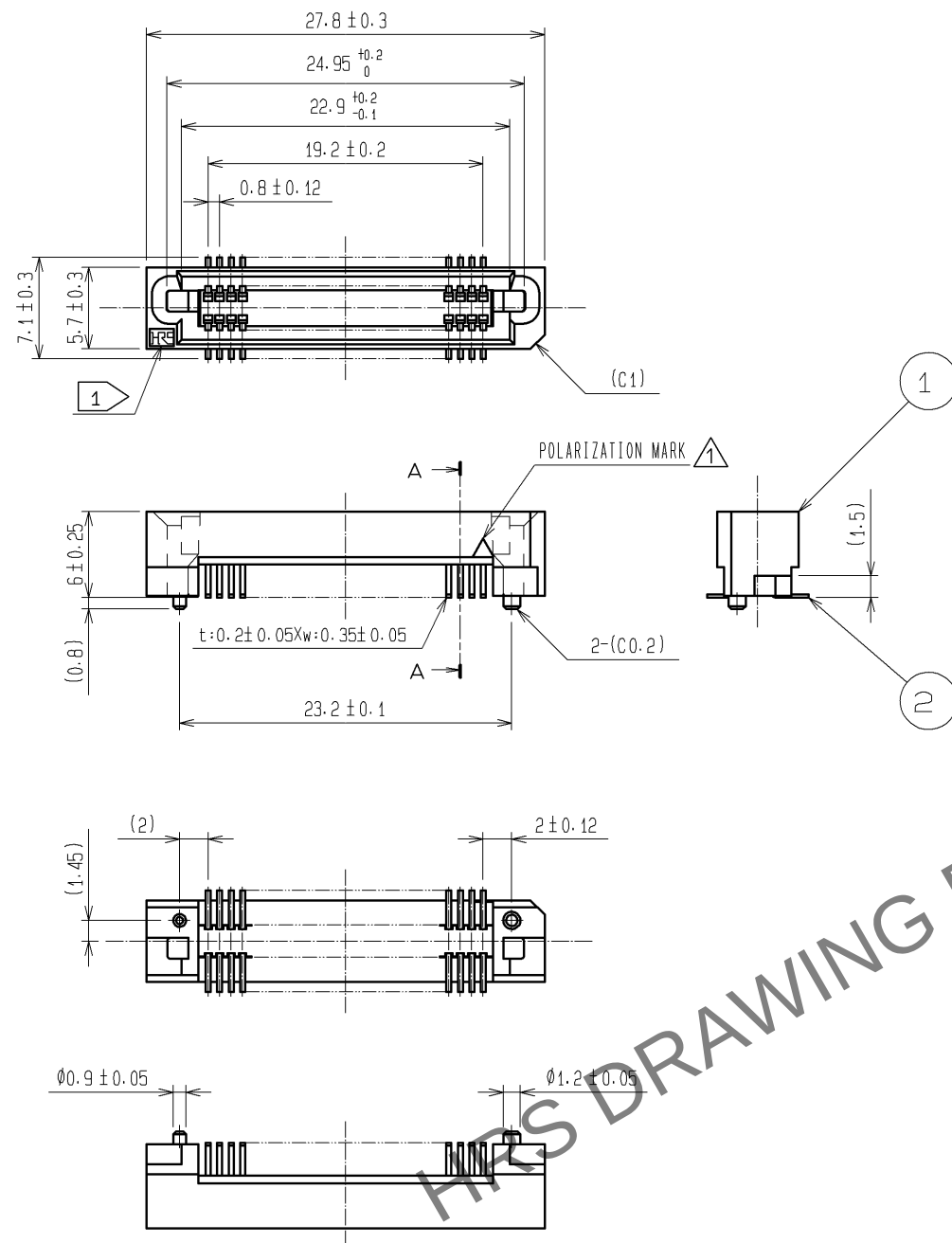
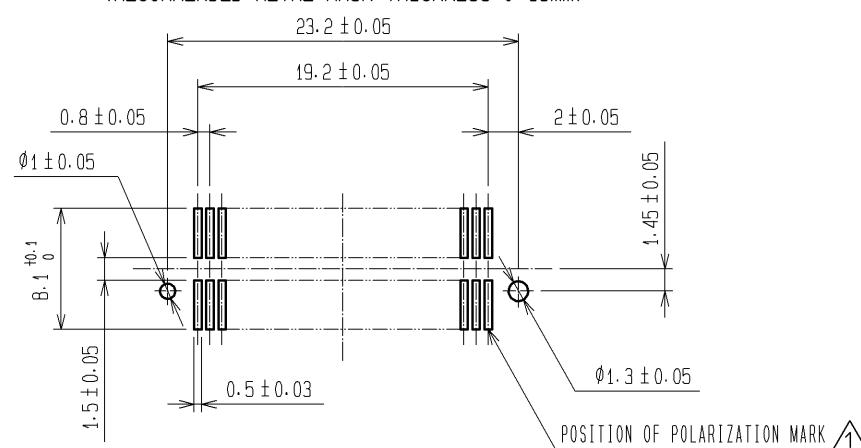




- NOTE
- 1 HRS MARK SHALL BE OPTIONAL.
 - 2 LEAD CO-PLANARITY SHALL BE 0.1mm MAX.
 - 3 EMBOSSED CARRIER TAPE PACKAGING SHALL BE APPLIED TO THIS PRODUCT. SEE NEXT PAGE FOR DETAILS.
 - 4 THIS PRODUCT HAS TAPE FOR VACUUM PICKUP. SEE NEXT PAGE FOR DETAIL OF STICKING POSITION, ETC.
 - 5 FOR MODIFICATION, ETC, PREVENTIVE HOLE FOR SINK MARK MAY BE ADDED ACCORDING TO CIRCUMSTANCES.
 - 6 THE DIMENSIONS IN PARENTHESES ARE FOR REFERENCE.

RECOMMENDED LAND PATTERN DIMENSION OF PCB (MOUNTING SIDE)
(RECOMMENDED METAL MASK THICKNESS: 0.15mm)



2	PHOSPHOR BRONZE	CONTACT AREA: GOLD 0.1μm min. LEAD AREA: TIN-PLATING 1μm min. UNDER PLATING: NICKEL 2μm min.							
1	PPS	LIGHT BROWN (UL94V-0)	5	POLYIMIDE	(TAPE FOR VUCUUM PICKUP)				
			4	POLYESTER	(TOP COVER TAPE)				
			3	POLYSTYRENE	(EMBOSSED CARRIER TAPE)				
NO.	MATERIAL	FINISH . REMARKS	NO.	MATERIAL	FINISH . REMARKS				
UNITS mm		SCALE 2 : 1	COUNT 2	DESCRIPTION OF REVISIONS DIS-F-003246		DESIGNED HK. SUNADORI	CHECKED HT. YAMAGUCHI	DATE 08.07.22	
		APPROVED : HS. OKAWA	08.06.13	DRAWING NO. EDC3-071641-23					
		CHECED : HT. YAMAGUCHI	08.06.13	PART NO. FX6-50S-0.8SV2(93)					
		DESIGNED : SY. KAMIGA	08.06.12	CODE NO. CL576-0124-3-93					
		DRAWN : HK. SUNADORI	08.06.12						

